

# **Device Selection Guide**

Code	Chip Materials	Emitted Color	Resin Color
Y2	AlGalnP	Brilliant Yellow	Water Olars
G6	AlGalnP	Brilliant Yellow Green	- Water Clear

Absolute Maximum Ratings (Ta=25℃)

Parameter Parameter	Symbol	Code	Rating	Unit
Reverse Voltage	$V_R$		5	V
		Y2	25	
Forward Current	I <sub>F</sub>	G6	25	− mA
eak Forward Current (Duty 1/10 @1KHz)	I <sub>FP</sub>	Y2	60	—— mA
		G6	60	
	Pd	Y2	60	
Power Dissipation		G6	60	− mW
Electrostatic Discharge	ESD <sub>HBM</sub>		2000	V
Operating Temperature	T <sub>opr</sub>		-40 ~ +85	$^{\circ}$ C
Storage Temperature	Tstg		-40 ~ +90	$^{\circ}\mathbb{C}$
Soldering Temperature	Tsol		Reflow Soldering : 260 $^{\circ}\mathbb{C}$ for 10 sec. Hand Soldering : 350 $^{\circ}\mathbb{C}$ for 3 sec.	



**Electro-Optical Characteristics (Ta=25℃)** 

Parameter	Symbol	Code	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	Y2	36.0		72.0	— mcd	
		G6	28.5		57.0	med	
Viewing Angle	2θ <sub>1/2</sub>			130		deg	
Peak Wavelength	λр	Y2		591		— nm	
	χр	G6		575		11111	
Dominant Wavelength	λd	Y2	585.5		594.5	— nm	I <sub>F</sub> =20mA
		G6	567.5		575.5	11111	
Spectrum Radiation Bandwidth	$\triangle \lambda$	Y2		15		— nm	
		G6		20		Ш	
Forward Voltage	$V_{F}$	Y2	1.7	2.0	2.4	— v	
		G6	1.7	2.0	2.4	V	
Reverse Current	I <sub>R</sub>	Y2			10	μΑ	V <sub>R</sub> =5V
		G6			10	μΛ	v R-0 v

### Note:

<sup>1.</sup>Tolerance of Luminous Intensity: ±11%

<sup>2.</sup> Tolerance of Dominant Wavelength ±1nm

<sup>3.</sup> Tolerance of Forward Voltage: ±0.10V



**Y2** 

**Bin Range of Luminous Intensity** 

Bin Code	Min.	Max.	Unit	Condition
N2	36.0	45.0		
P1	45.0	57.0	mcd	$I_F = 20 \text{mA}$
P2	57.0	72.0	_	

Bin Range Of Dom. Wavelength

Bin Code	Min.	Max.	Unit	Condition
D3	585.5	588.5	_	
D4	588.5	591.5	nm	I <sub>F</sub> =20mA
D5	591.5	594.5	_	

G6

**Bin Range of Luminous Intensity** 

Bin Code	Min.	Max.	Unit	Condition
N1	28.5	36.0		
N2	36.0	45.0	mcd	$I_F = 20 \text{mA}$
P1	45.0	57.0	_	

Bin Range Of Dom. Wavelength

Bin Code	Min.	Max.	Unit	Condition
C15	567.5	569.5		
C16	569.5	571.5		J. 00 A
C17	571.5	573.5	mm nm	I <sub>F</sub> =20mA
C18	573.5	575.5		

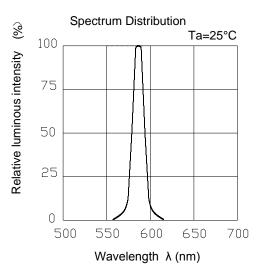
Note:

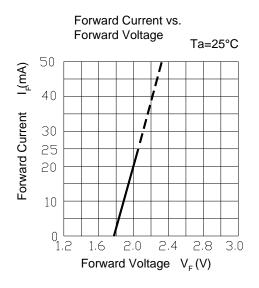
1.Tolerance of Luminous Intensity: ±11%

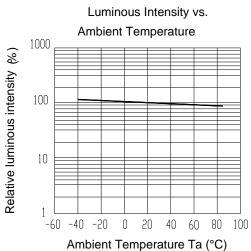
2.Tolerance of Dominant Wavelength ±1nm

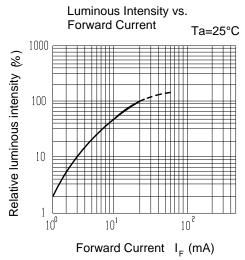
## **Typical Electro-Optical Characteristics Curves**

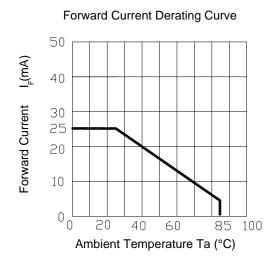
### **Y2**

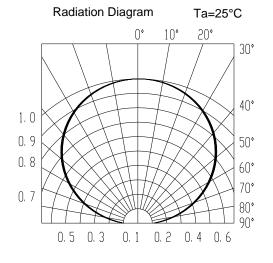






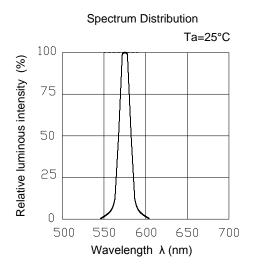


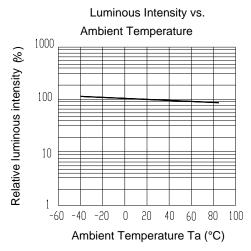


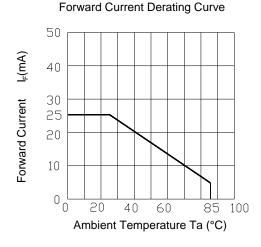


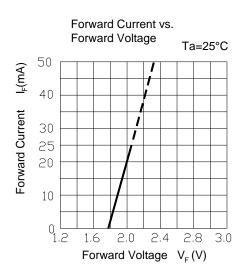
## **Typical Electro-Optical Characteristics Curves**

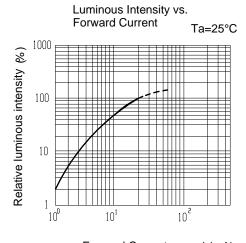
G6

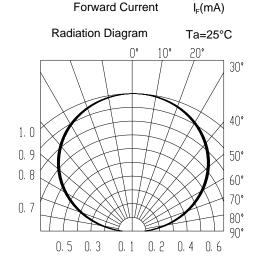






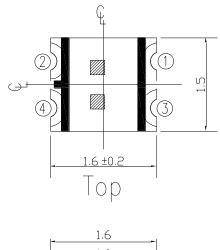


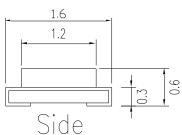


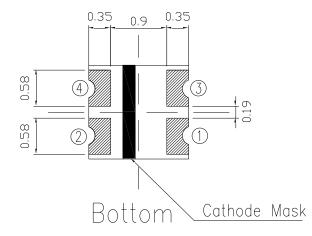


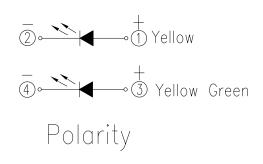


# **Package Dimension**

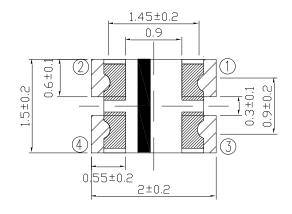








Recommend soldering pad

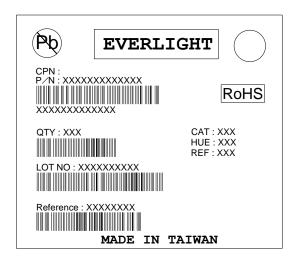


Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

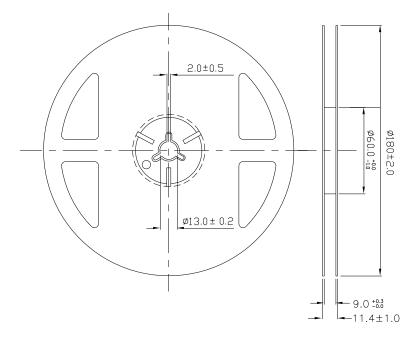


# **Label Explanation**



- CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- · REF: Forward Voltage Rank
- · LOT No: Lot Number

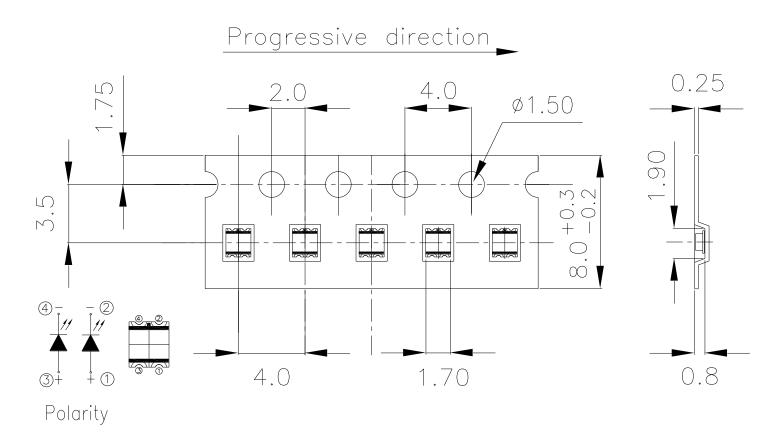
### **Reel Dimensions**



Note: The tolerances unless mentioned is  $\pm 0.1 \text{mm}$ , Unit = mm

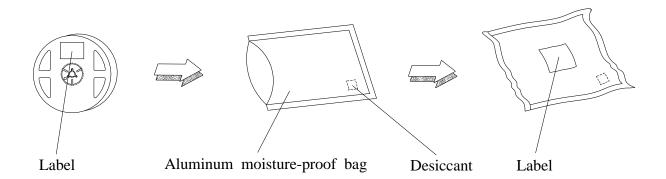


# Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is  $\pm 0.1$ mm ,Unit = mm

## **Moisture Resistant Packaging**





#### **Precautions For Use**

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

### 2. Storage

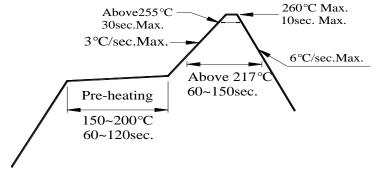
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less.

If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment:  $60\pm5^{\circ}$ C for 24 hours.

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile



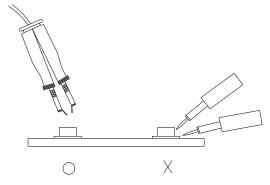
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





## **Application Restrictions**

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.